Having agreed to put into effect the results of these negotiations which involve concessions additional to those included in the Schedules attached to the Marrakesh Protocol to the General Agreement on Tariffs and Trade 1994, and

Recognizing that the results of these negotiations also involve some concessions offered in negotiations leading to the establishment of Schedules annexed to the Marrakesh Protocol,

Declare as follows:

- 1. Each party's trade regime should evolve in a manner that enhances market access opportunities for information technology products.
- 2. Pursuant to the modalities set forth in the Annex to this Declaration, each party shall bind and eliminate customs duties and other duties and charges of any kind, within the meaning of Article II:1(b) of the General Agreement on Tariffs and Trade 1994, with respect to the following:
 - (a) all products classified (or classifiable) with Harmonized System (1996) ("HS") headings listed in Attachment A to the Annex to this Declaration; and
 - (b) all products specified in Attachment B to the Annex to this Declaration, whether or not they are included in Attachment A;

through equal rate reductions of customs duties beginning in 1997 and concluding in 2000, recognizing that extended staging of reductions and, before implementation, expansion of product coverage may be necessary in limited circumstances.

- 3. Ministers express satisfaction about the large product coverage outlined in the Attachments to the Annex to this Declaration. They instruct their respective officials to make good faith efforts to finalize plurilateral technical discussions in Geneva on the basis of these modalities, and instruct these officials to complete this work by 31 January 1997, so as to ensure the implementation of this Declaration by the largest number of participants.
- 4. Ministers invite the Ministers of other Members of the WTO, and States or separate customs territories in the process of acceding to the WTO, to provide similar instructions to their respective officials, so that they may participate in the technical discussions referred to in paragraph 3 above and participate fully in the expansion of world trade in information technology products.

Annex: Modalities and Product Coverage

Attachment A: list of HS headings

Attachment B: list of products

(ii) in the case of the products specified in Attachment B, by attaching an annex to its Schedule including all products in Attachment B, which is to specify the detailed HS headings for those products at either the national tariff line level or the HS 6-digit level.

Each participant shall promptly modify its national tariff schedule to reflect the modifications it has proposed, as soon as they have entered into effect.

- 3. Participants shall meet periodically under the auspices of the Council on Trade in Goods to review the product coverage specified in the Attachments, with a view to agreeing, by consensus, whether in the light of technological developments, experience in applying the tariff concessions, or changes to the HS nomenclature, the Attachments should be modified to incorporate additional products, and to consult on non-tariff barriers to trade in information technology products. Such consultations shall be without prejudice to rights and obligations under the WTO Agreement.
- 4. Participants shall meet as soon as practicable and in any case no later than 1 April 1997 to review the state of acceptances received and to assess the conclusions to be drawn therefrom. Participants will implement the actions foreseen in the Declaration provided that participants representing approximately 90 per cent of world trade² in information technology products have by then notified their acceptance, and provided that the staging has been agreed to the participants' satisfaction. In assessing whether to implement actions foreseen in the Declaration, if the percentage of world trade represented by participants falls somewhat short of 90 per cent of world trade in information technology products, participants may take into account the extent of the participation of States or separate customs territories representing for them the substantial bulk of their own trade in such products. At this meeting the participants will establish whether these criteria have been met.
- 5. Participants shall meet as often as necessary and no later than 30 September 1997 to consider any divergence among them in classifying information technology products, beginning with the products specified in Attachment B. Participants agree on the common objective of achieving, where appropriate, a common classification for these products within existing HS nomenclature, giving consideration to interpretations and rulings of the Customs Co-operation Council (also known as the World Customs Organization or "WCO"). In any instance in which a divergence in classification remains, participants will consider whether a joint suggestion could be made to the WCO with regard to updating existing HS nomenclature or resolving divergence in interpretation of the HS nomenclature.
- 6. The participants understand that Article XXIII of the General Agreement will address nullification or impairment of benefits accruing directly or indirectly to a WTO Member participant through the implementation of this Declaration as a result of the application by another WTO Member participant of any measure, whether or not that measure conflicts with the provisions of the General Agreement.
- 7. Each participant shall afford sympathetic consideration to any request for consultation from any other participant concerning the undertakings set out above. Such consultations shall be without prejudice to rights and obligations under the WTO Agreement.
- 8. Participants acting under the auspices of the Council for Trade in Goods shall inform other Members of the WTO and States or separate customs territories in the process of acceding to the WTO of these modalities and initiate consultations with a view to facilitate their participation in the expansion of trade in information technology products on the basis of the Declaration.

²This percentage shall be calculated by the WTO Secretariat on the basis of the most recent data available at the time of the meeting.

- 9. As used in these modalities, the term "participant" shall mean those Members of the WTO, or States or separate customs territories in the process of acceding to the WTO, that provide the document described in paragraph 2 no later than 1 March 1997.
- 10. This Annex shall be open for acceptance by all Members of the WTO and any State or any separate customs territory in the process of acceding to the WTO. Acceptances shall be notified in writing to the Director-General who shall communicate them to all participants.

re two attachments to the Annex.
nent A lists the HS headings or parts thereof to be covered.
nent B lists specific products to be covered by an ITA wherever they are classified in the HS.

Attachment A, Section 1

| HS96 | | HS description |
|------|----|--|
| 3818 | | Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics |
| 8469 | 11 | Word processing machines |
| 8470 | | Calculating machines and pocket-size data recording, reproducing and displaying machines with a calculating function; accounting machines, postage franking machines, ticket-issuing machines and similar machines, incorporating a calculating devices; cash registers: |
| 8470 | 10 | Electronic calculators capable of operating without an external source of electric power and pocket size data recording, reproducing and displaying machines with calculating functions |

| | 8471 | 70 | Storage units, including central storage units, optical |
|----|------|-----|---|
| | 0471 | 7.0 | disk storage units, hard disk drives and magnetic tape |
| | | | storage units |
| | 8471 | 80 | Other units of automatic data processing machines |
| | 8471 | 90 | Other |
| ex | 8472 | 90 | Automatic teller machines |
| | 8473 | 21 | Parts and accessories of the machines of heading No 8470 |
| | | | of the electronic calculating machines of subheading 8470 |
| | | | 10, 8470 21 and 8470 29 |
| | 8473 | 29 | Parts and accessories of the machines of heading No 8470 other than the electronic calculating machines of |
| | | | subheading 8470 10, 8470 21 and 8470 29 |
| | 8473 | 30 | Parts and accessories of the machines of heading No 8471 |
| | 8473 | 50 | Parts and accessories equally suitable for use with |
| | | | machines of two or more of the headings Nos. 8469 to 8472 |
| ex | 8504 | 40 | Static converters for automatic data processing machines |
| | | | and units thereof, and telecommunication apparatus |
| ex | 8504 | 50 | Other inductors for power supplies for automatic data |
| | | | processing machines and units thereof, and telecommunication apparatus |
| | 8517 | | Electrical apparatus for line telephony or line |
| | 0317 | | telegraphy, including line telephone sets with cordless |
| | | | handsets and telecommunication apparatus for |
| | | | carrier-current line systems or for digital line systems; |
| | 0515 | | videophones: |
| | 8517 | 11 | Line telephone sets with cordless handsets |
| | 8517 | 19 | Other telephone sets and videophones |
| | 8517 | 21 | Facsimile machines |
| | 8517 | 22 | Teleprinters |
| | 8517 | 30 | Telephonic or telegraphic switching apparatus |
| | 8517 | 50 | Other apparatus, for carrier-current line systems or for |
| | 8517 | 80 | digital line systems |
| | 8517 | 90 | Other apparatus including entry-phone systems Parts of apparatus of heading 8517 |
| ex | 8518 | 10 | Microphones having a frequency range of 300 Hz to 3,4 KHz |
| ex | 0210 | 10 | with a diameter of not exceeding 10 mm and a height not |
| | | | |
| ex | 8518 | 30 | Line telephone handsets |
| ex | 8518 | 29 | Loudspeakers, without housing, having a frequency range of |
| | | | 300 Hz to 3,4 KHz with a diameter of not exceeding 50 mm, |
| | 0500 | | |
| | | | |
| | 8523 | 11 | - |
| | | | |
| | 8523 | 12 | Magnetic tapes of a width exceeding 4 mm but not exceeding 6,5 mm |
| | | | exceeding 3 mm, for telecommunication use Line telephone handsets Loudspeakers, without housing, having a frequency range 300 Hz to 3,4 KHz with a diameter of not exceeding 50 m for telecommunication use Telephone answering machines Magnetic tapes of a width not exceeding 4 mm |

| | 8523 | 20 | Magnetic discs |
|----|------|----|---|
| | 8523 | 90 | Other |
| | 8524 | 31 | Discs for laser reading systems for reproducing phenomena other than sound or image |
| ex | 8524 | 39 | Other: - for reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine |
| | 8524 | 40 | Magnetic tapes for reproducing phenomena other than sound or image |
| | 8524 | 91 | Media for reproducing phenomena other than sound or image |
| ex | 8424 | 99 | Other: - for reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine |

ex 8525 10 Transmission apparatus other than apparatus for radioathan soundTransmiss5 re f manipulated o6-5 re 139.5 543 1

| | 8532 | 90 | Parts |
|----|----------------------|----------------|---|
| | 8533 | | Electrical resistors (including rheostats and potentiometers), other than heating resistors: |
| | 8533 | 10 | Fixed carbon resistors, composition or film types |
| | 8533 | 21 | Other fixed resistors for a power handling capacity not exceeding 20 W |
| | 8533 | 29 | Other fixed resistors for a power handling capacity of 20 W or more |
| | 8533 | 31 | Wirewound variable resistors, including rheostats and potentiometers, for a power handling capacity not exceeding 20 W |
| | 8533 | 39 | Wirewound variable resistors, including rheostats and potentiometers, for a power handling capacity of 20 W or more |
| | 8533 | 40 | Other variable resistors, including rheostats and potentiometers |
| | 8533 | 90 | Parts |
| | 8534 | | Printed circuits |
| ex | 8536 | 50 | Electronic AC switches consisting of optically coupled input and output circuits (Insulated thyristor AC switches) |
| ex | 8536 | 50 | Electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology) for a voltage not exceeding 1000 volts |
| ex | 8536 | 50 | Electromechanical snap-action switches for a current not exceeding 11 amps |
| ex | 8536 | 69 | Plugs and sockets for co-axial cables and printed circuits |
| ex | 8536 | 90 | Connection and contact elements for wires and cables |
| | 8541 | | Diodes, transistors and similar semiconductor devices; photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light-emitting diodes; mounted piezo-electric crystals: |
| | 8541 | 10 | Diodes, other than photosensitive or light-emitting diodes |
| | 8541 | 21 | Transistors, other than photosensitive transistors, with a dissipation rate of less than 1 \mbox{W} |
| | 8541 | 29 | Transistors, other than photosensitive transistors, with a dissipation rate of 1 W or more |
| | 8541 | 30 | Thyristors, diacs and triacs, other than photosensitive devices |
| | 8541 | 40 | Photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes |
| | | | |
| | 8541 | 50 | Other semiconductor devices |
| | 8541 8541 8541 | 50 60 90 | |

ratus, incorporating an optical p t i

C

| | 9027 | 50 | Other instruments and apparatus using optical radiations (UV, visible, IR) of heading No 9027 |
|----|------|----|--|
| | 9027 | 80 | Other instruments and apparatus of heading No 9027 (other than those of heading No 9027 10) |
| ex | 9027 | 90 | Parts and accessories of products of heading 9027, other than for gas or smoke analysis apparatus and microtomes |
| | 9030 | 40 | Instruments and apparatus for measuring and checking, specially designed for telecommunications (for example, cross-talk meters, gain measuring instruments, distorsion factor meters, psophometers) |

Attachment A, Section 2

Semiconductor manufacturing and testing equipment and parts thereof

| | HS Code | Description | | | Comments | |
|----|---------|-------------|--|---|----------|--|
| ex | 7017 10 | Quartz read | | _ | | |

ex 8466 91

| | | semiconductor wafers | ٦ |
|----|---------|----------------------|---|
| ex | 8479 89 | | - |

| | | В | |
|----|---------|---|--|
| ex | 8514 30 | | |

| | ı | | |
|----|---------|--|------------------------|
| | | designed for the handling and transport of semiconductor wafers or reticles | В |
| ex | 9017 20 | Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates | For Attachment B |
| ex | 9017 90 | Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates | For Attachment B |
| ex | 9017 90 | Parts of such pattern generating apparatus | For Attachment B |
| | 9030 82 | Instruments and apparatus for measuring or checking semiconductor wafers or devices | |
| ex | 9030 90 | Parts and accessories of instruments and apparatus for measuring or checking semiconductor wafers or devices | |
| ex | 9030 90 | Parts of instruments and appliances for measuring or checking semiconductor wafers or devices | |
| | 9031 41 | Optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices | |
| ex | 9031 49 | Optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers | |
| ex | 9031 90 | Parts and accessories of optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices | |
| ex | 9031 90 | Parts and accessories of optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers | |

Attachment B

Positive list of specific products to be covered by this agreement wherever they are classified in the HS.

Where parts are specified, they are to be covered in accordance